1-534206-2 - ACTIVE

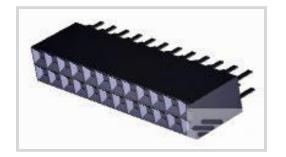
AMPMODU | Modu Connector System

TE Internal #: 1-534206-2 Modu Connector System, PCB Mount Receptacle, Vertical, Boardto-Board, 24 Position, .1 in [2.54 mm] Centerline, Gold, Through Hole - Solder, Signal

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 24

Number of Rows: 2

Features

Product Type Features

Applied Pressure

PCB Connector Assembly Type

Connector System

Standard

PCB Mount Receptacle

Board-to-Board

Sealable	No			
Connector & Contact Terminates To	Printed Circuit Board			
Configuration Features				
Stackable	Yes			
PCB Mount Orientation	Vertical			
Number of Positions	24			
Number of Rows	2			
Board-to-Board Configuration	Parallel			
Electrical Characteristics				
Insulation Resistance	5000 MΩ			
Operating Voltage	333 VAC			
Body Features				
Connector Profile	Standard			
Primary Product Color	Black			
Contact Features				

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Modu Connector System, PCB Mount Receptacle, Vertical, Board-to-Board, 24 Position, .1 in [2.54 mm] Centerline, Gold, Through Hole - Solder, Signal



Contact Protection Type	Closed Entry Housing	
Mating Square Post Dimension	.64 mm[.025 in]	
	150 µin	
Contact Shape & Form	Square	
PCB Contact Termination Area Plating Material	Tin-Lead	
Contact Base Material	Phosphor Bronze	
Contact Mating Area Plating Material	Gold	
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]	
Contact Type	Socket	
Contact Current Rating (Max)	2 A	
Termination Features		
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]	
Rectangular Termination Post & Tail Width	.69 mm[.027 in]	
Termination Post & Tail Length	2.92 mm[.115 in]	
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
Mating Alignment	Without	
PCB Mount Retention	Without	
PCB Mount Alignment	Without	
Connector Mounting Type	Board Mount	
Housing Features		
Mating Entry Location	Тор	
Centerline (Pitch)	2.54 mm[.1 in]	
Housing Material	Polyester - GF	
Dimensions		
Connector Height	5.03 mm[.198 in]	
Row-to-Row Spacing	2.54 mm[.1 in]	
Stack Height	10.92 mm[.43 in]	
PCB Thickness (Recommended)	1.57 mm[.055 – .094 in]	
Jsage Conditions		
	Standard	
Housing Temperature Rating	Standard	

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Operation/Application

Solder Process Feature	Board Standoff		
Circuit Application	Signal		
Industry Standards			
Approved Standards	CSA LR7189, UL E28476		
UL Flammability Rating	UL 94V-0		
Packaging Features			
Packaging Quantity	18		
Packaging Type	Box, Tube		
Product Compliance			
For compliance documentation, visit the product page on TE.com>			
EU RoHS Directive 2011/65/EU	Not Compliant		
EU ELV Directive 2000/53/EC	Not Compliant		
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold		
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2022 (223) Candidate List Declared Against: JAN 2022 (223)		

(223)

SVHC > Threshold:

Pb (13% in Component Part)

Article Safe Usage Statements:

Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Not Low Halogen - contains Br or Cl > 900

ppm.

Wave solder capable to 240°C

Halogen Content

Solder Process Capability

Product Compliance Disclaimer

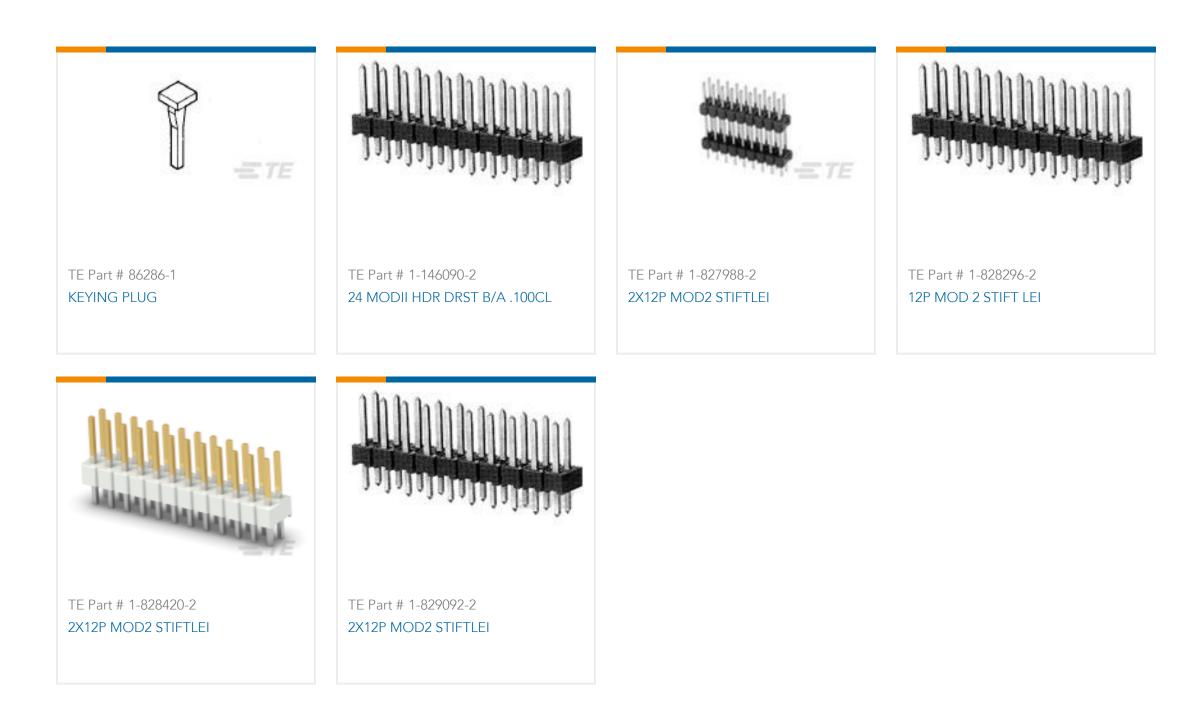
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

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Also in the Series | Modu Connector System



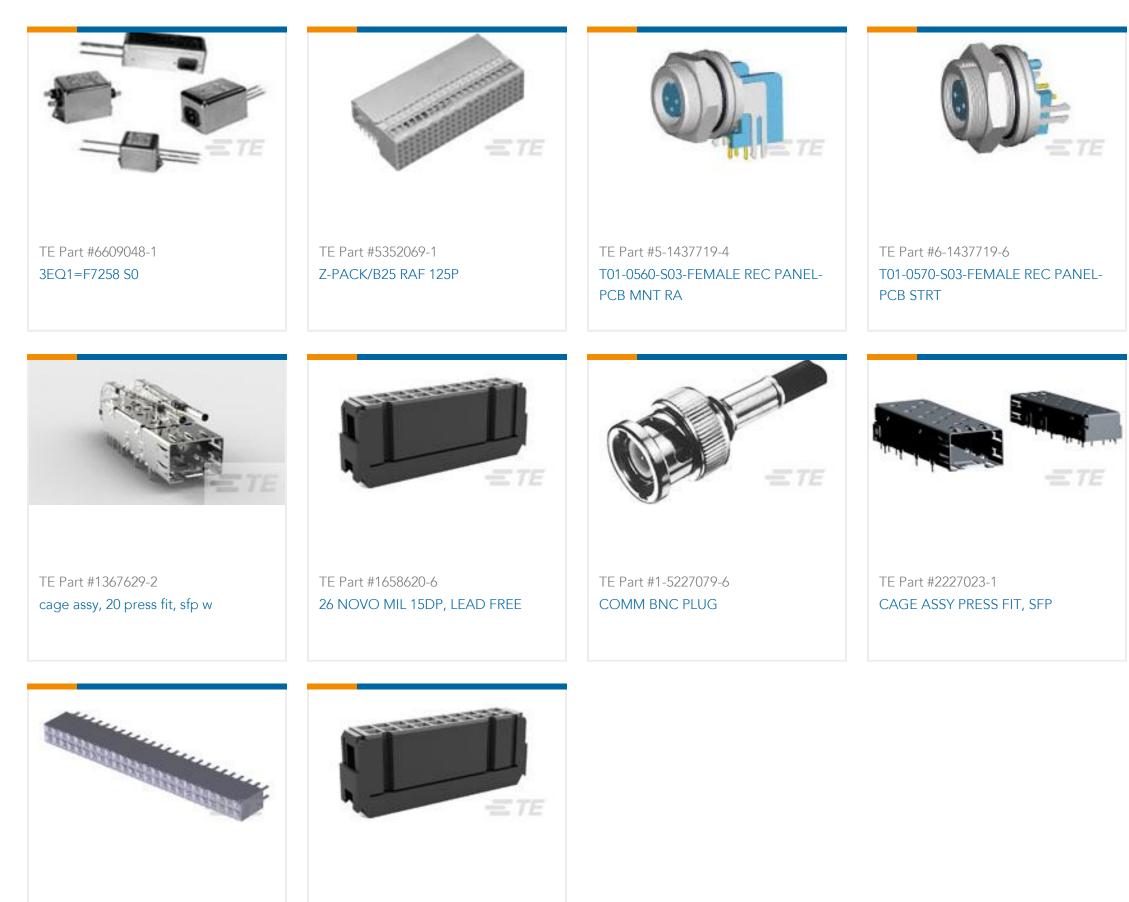
Automotive Housings(2)	Board-to-Board Jumpers & Shunts(5)	PCB Connector Covers(4)	PCB Connector Keying(4)



Customers Also Bought

Modu Connector System, PCB Mount Receptacle, Vertical, Board-to-Board, 24 Position, .1 in [2.54 mm] Centerline, Gold, Through Hole - Solder, Signal





TE Part #2-534206-5 50 MODII VRT DR CE 100/115 TE Part #1658620-5 24 NOVO MIL 15DP, LEAD FREE

Documents

Product Drawings 24 MODII VRT DR CE 100/115

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-534206-2_N.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-534206-2_N.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-534206-2_N.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

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Application Specification

English